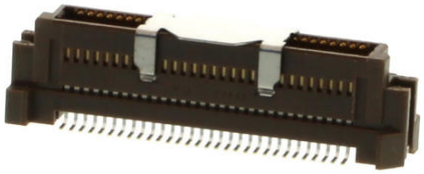
Part Number : 536490674
Product Description : SlimStack Board-to-Board Connector, 0.635mm Pitch, 0.635 Series, Plug, 9.00 or 15.00mm Mated Height, 6.40mm Mated Width, 60 Circuits
Series Number : 53649
Status : Active
Product Category : Board-to-Board Connectors



Documents & Resources

Drawings

536490674_sd.pdf

3D Models and Design Files

STEP AP242

SOLIDWORKS

Creo

Symbol and Footprint (Multi-Format)

Specifications

SPK-53649-001-001.pdf

527600000-000.pdf

Product Environment Compliance

Compliance

GADSL/IMDS	Not Relevant
China RoHS	per SJ/T 11365-2006
EU ELV	Not Relevant
Low-Halogen Status	Low-Halogen per IEC 61249-2-21
REACH SVHC	Not Contained per D(2025)4165-DC (25 June 2025)
EU RoHS	Compliant per EU 2015/863

Compliance Statements

- EU RoHS
- REACH SVHC
- Low-Halogen

Industry Documents
- IPC 1752A Class C
- IPC 1752A Class D
- Molex Product Compliance Declaration
- IEC-62474
- chemSHERPA (xml)

Substances of Interest
- PFAS

EU RoHS Certificate of Compliance

Additional Product Compliance Information

Part Details

General

Status	Active
Category	Board-to-Board Connectors
Series	0.635, Floating, Rigid
Description	SlimStack Board-to-Board Connector, 0.635mm Pitch, 0.635 Series, Plug, 9.00 or 15.00mm Mated Height, 6.40mm Mated Width, 60 Circuits
Application	Board-to-Board, Signal
Comments	Stacking-Type
Component Type	PCB Header
Product Name	SlimStack
UPC	822348184156

Electrical

Current - Maximum per Contact	0.5A
Voltage - Maximum	100V

Physical

Breakaway	No
Circuits (Loaded)	60

Circuits (maximum)	60
Color - Resin	Natural
Durability (mating cycles max)	50
First Mate / Last Break	No
Glow-Wire Capable	No
Guide to Mating Part	No
Keying to Mating Part	None
Lock to Mating Part	Yes
Mated Height	15.00mm, 9.00mm
Mated Width	6.40mm
Material - Metal	Copper Alloy
Material - Plating Mating	Gold
Material - Plating Termination	Tin
Material - Resin	High Temperature Thermoplastic
Net Weight	1176.021/mg
Number of Rows	2
Orientation	Vertical
Packaging Type	Embossed Tape on Reel
PCB Locator	Yes
PCB Retention	Yes
PCB Thickness - Recommended	1.00mm min
Pitch - Mating Interface	0.635mm
Plating min - Mating	0.254µm
Plating min - Termination	2.032µm
Polarized to PCB	Yes
Robotic Placement	Metal Cap
Shrouded	Fully
Temperature Range - Operating	-55° to +105°C
Termination Interface Style	Surface Mount

Solder Process Data

Lead-Free Process Capability	REFLOW
Max-Cycle	1
Max-Temp	250

Mates With / Use With

Mates with Part(s)

Description	Part Number
0.635mm Pitch Vertical SlimStack Receptacles	52885
0.635mm Pitch Vertical SlimStack Receptacles	52901